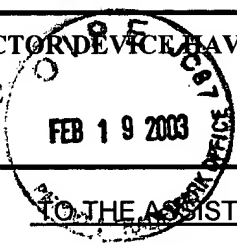


2823

AMENDMENT TRANSMITTAL LETTER (Large Entity)		Docket No. SEC.747	
Applicant(s): In-sung KIM et al.			

Serial No. 09/640,754	Filing Date 18 August 2000	Examiner Hsien Ming LEE	Group Art Unit 2823
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Invention: SEMICONDUCTOR DEVICE HAVING SELF-ALIGNED CONTACT AND METHOD OF FABRICATING THE SAME



TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.
The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	14 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	3 -	3 =	0 x	\$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of _____ to cover the filing fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. **50- 0238**
A duplicate copy of this sheet is enclosed.
 - ☒ Any additional filing fees required under 37 C.F.R. 1.16.
 - ☒ Any patent application processing fees under 37 CFR 1.17.

Signature

Dated: 19 February 2003

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I certify that this document and fee is being deposited on _____ with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.
Signature of Person Mailing Correspondence
Typed or Printed Name of Person Mailing Correspondence

CC:



SEC.747

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of:

In-sung KIM et al.

Group Art Unit: 2823

Serial No.: 09/640,754

Examiner: Hsien Ming LEE

Filed: 18 August 2000

SEMICONDUCTOR DEVICE
HAVING SELF-ALIGNED
CONTACT AND METHOD OF
FABRICATING THE SAME

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AMENDMENT

Honorable Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action dated 18 November 2002, please amend the
above-identified patent application as follows:

IN THE CLAIMS:

Please substitute the following claims for the pending claims with the same
claim numbers.

2. (Amended) A method of fabricating a semiconductor device, comprising:

forming a conductive region at the top of a semiconductor substrate;

forming a first interlayer dielectric layer on the semiconductor substrate over
the entirety of the conductive region;